



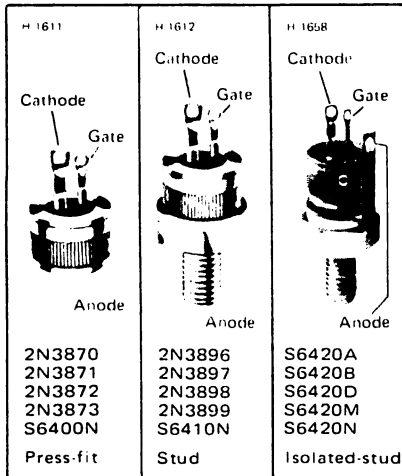
SOLID STATE INC.

46 FARRAND STREET
BLOOMFIELD, NEW JERSEY 07003

www.solidstateinc.com

Thyristors

2N3870-2N3873, S6400N
2N3896-2N3899, S6410N
S6420A, B, D, M, N



35-A Silicon Controlled Rectifiers

Press-Fit, Stud, and Isolated-Stud Packages

For Low-Voltage Operation—2N3870, 2N3896, S6420A
For 120-V Line Operation—2N3871, 2N3897, S6420B
For 240-V Line Operation—2N3872, 2N3898, S6420D
For High-Voltage Operation—2N3873, 2N3899, S6420M
S6400N S6401N S6420N

Features:

- High di/dt and dv/dt capabilities
- Low on-state voltage at high current levels
- Low thermal resistance
- Shorted-emitter gate-cathode construction . . . contains an internally diffused resistor between gate and cathode
- Center gate construction . . . provides rapid uniform gate-current spreading for faster turn-on with substantially reduced heating effects

These types are all-diffused, silicon controlled rectifiers (reverse-blocking triode thyristors) designed for power switching, power control, and voltage regulator applications and for heating, lighting, and motor speed-control circuits.

MAXIMUM RATINGS, Absolute-Maximum Values:

| | 2N3870 2N3896 S6420A | 2N3871 2N3897 S6420B | 2N3872 2N3898 S6420D | 2N3873 2N3899 S6420M | S6400N S6410N S6420N | | |
|--|----------------------------|-----------------------------|----------------------------|----------------------------|----------------------------|-----|------------------|
| *NON-REPETITIVE PEAK REVERSE VOLTAGE[▲] | | | | | | | |
| Gate Open | V_{RSOM} | 150 | 330 | 660 | 700 | 900 | V |
| NON-REPETITIVE PEAK OFF-STATE VOLTAGE[▲] | | | | | | | |
| Gate Open | V_{DSOM} | 150 | 330 | 660 | 700 | 900 | V |
| *REPETITIVE PEAK REVERSE VOLTAGE[▲] | | | | | | | |
| Gate Open | V_{RROM} | 100 | 200 | 400 | 600 | 800 | V |
| *REPETITIVE PEAK OFF-STATE VOLTAGE[▲] | | | | | | | |
| Gate Open | V_{DROM} | 100 | 200 | 400 | 600 | 800 | V |
| ON-STATE CURRENT: | | | | | | | |
| $T_C = 65^\circ\text{C}^*$, conduction angle = 180° : | | | | | | | |
| RMS | $I_T(\text{RMS})$ | _____ 35 _____ | | | | | A |
| Average | $I_T(\text{AV})$ | _____ 22 _____ | | | | | A |
| For other conditions | | _____ See Figs. 3 & 5 _____ | | | | | |
| PEAK SURGE (NON-REPETITIVE) ON-STATE CURRENT: | I_{TSM} | | | | | | |
| For one full cycle of applied principal voltage | | | | | | | |
| 60 Hz (sinusoidal) | | _____ 350 _____ | | | | | A |
| 50 Hz (sinusoidal) | | _____ 300 _____ | | | | | A |
| For more than one full cycle of applied principal voltage | | _____ See Fig. 5 _____ | | | | | |
| RATE OF CHANGE OF ON-STATE CURRENT | | | | | | | |
| $V_D = V_{DROM}$, $I_{GT} = 200\text{ mA}$, $t_r = 0.5\ \mu\text{s}$ (See Fig. 13) | di/dt | _____ 200 _____ | | | | | A/ μs |
| FUSING CURRENT (for SCR protection): | | | | | | | |
| $T_J = -40\text{ to }100^\circ\text{C}$, $t = 1\text{ to }8.3\text{ ms}$ | I^2t | _____ 300 _____ | | | | | A ² s |
| GATE POWER DISSIPATION[●]: | | | | | | | |
| Peak Forward (for $10\ \mu\text{s}$ max., See Fig. 8) | P_{GM} | _____ 40 _____ | | | | | W |
| Peak Reverse | P_{RGM} | _____ See Fig. 9 _____ | | | | | |
| Average (averaging time = 10 ms max.) | $P_{G(\text{AV})}$ | _____ 0.5 _____ | | | | | W |
| *TEMPERATURE RANGE[■]: | | | | | | | |
| Storage | | _____ -40 to 125 _____ | | | | | $^\circ\text{C}$ |
| Operating (Case) | | _____ -40 to 100 _____ | | | | | $^\circ\text{C}$ |
| TERMINAL TEMPERATURE (During soldering): | T_T | | | | | | |
| For 10 s max. (terminals and case) | | _____ 225 _____ | | | | | $^\circ\text{C}$ |

* In accordance with JEDEC registration data filed for the JEDEC (2N-series) types.
 ▲ These values do not apply if there is a positive gate signal. Gate must be open or negatively biased.
 ● $T_C = 60^\circ$ for isolated-stud package types.
 ■ Any product of gate current and gate voltage which results in a gate power less than the maximum is permitted.
 ■ Temperature measurement point is shown on the DIMENSIONAL OUTLINE.

ELECTRICAL CHARACTERISTICS

At Maximum Ratings Unless Otherwise Specified and at Indicated Case Temperature (T_C)

| CHARACTERISTIC | SYMBOL | LIMITS | | | UNITS |
|---|------------------------------|---|----------------------------|------------------------|--------------------|
| | | FOR ALL TYPES Unless Otherwise Specified | | | |
| | | MIN. | TYP. | MAX. | |
| Peak Off-State Current: (Gate open, $T_C = 100^\circ\text{C}$) Forward Current (I_{DOM}) at $V_D = V_{DROM}$ Reverse Current (I_{ROM}) at $V_R = V_{RROM}$ 2N3870, 2N3896, S6420A 2N3871, 2N3897, S6420B 2N3872, 2N3898, S6420D 2N3873, 2N3899, S6420M, S6400N, S6410N, S6420N | I_{DOM} or I_{ROM} | — — — — | 0.2 0.25 0.3 0.35 | 2* 2.5* 3* 4* | mA |
| Instantaneous On-State Voltage: $i_T = 69$ A (peak), $T_C = 25^\circ\text{C}$ $i_T = 100$ A (peak), $T_C = 25^\circ\text{C}$ | v_T | — — | — 1.7 | 1.85* 2.1 | V |
| DC Gate Trigger Voltage: $V_D = 12$ V (dc), $R_L = 30 \Omega$, $T_C = -40^\circ\text{C}$ $V_D = 12$ V (dc), $R_L = 30 \Omega$, $T_C = 25^\circ\text{C}$ For other case temperatures | V_{GT} | — — | 1.5 1.1 See Fig. 11 | 3* 2 | V |
| DC Gate Trigger Current: $V_D = 12$ V (dc), $R_L = 30 \Omega$, $T_C = -40^\circ\text{C}$ $V_D = 12$ V (dc), $R_L = 30 \Omega$, $T_C = 25^\circ\text{C}$ For other case temperatures | I_{GT} | — 1 | 46 25 See Fig. 10 | 80* 40 | mA |
| Instantaneous Holding Current: Gate open, $T_C = 25^\circ\text{C}$ For other case temperatures | i_{HO} | 0.5 | 30 See Fig. 7 | 70 | mA |
| Gate Controlled Turn-On Time: (Delay Time + Rise Time) For $V_D = V_{DROM}$, $I_{GT} = 200$ mA, $t_r = 0.1 \mu\text{s}$, $I_T = 30$ A (peak), $T_C = 25^\circ\text{C}$ (See Fig. 12 & 14.) | t_{gt} | — | 1.25 | 2 | μs |
| Circuit Commutated Turn-Off Time: $V_D = V_{DROM}$, $i_T = 18$ A, pulse duration = $50 \mu\text{s}$, $dv/dt = 20$ V/ μs , $-di/dt$ = -30 A/ μs , $I_{GT} = 200$ mA, $T_C = 80^\circ\text{C}$ (See Fig. 15.) | t_q | — | 20 | 40 | μs |
| Critical Rate of Rise of Off-State Voltage: $V_D = V_{DROM}$, exponential voltage rise, Gate open, $T_C = 100^\circ\text{C}$ (See Fig. 16.) | dv/dt | 10 | 100 | — | V/ μs |
| Thermal Resistance, Junction-to-Case: Steady-State Press-fit & stud types Isolated-stud types | $R_{\theta JC}$ | — — | — — | 0.9* 1 | $^\circ\text{C/W}$ |

*In accordance with JEDEC registration data filed for the JEDEC (2N-series) types.

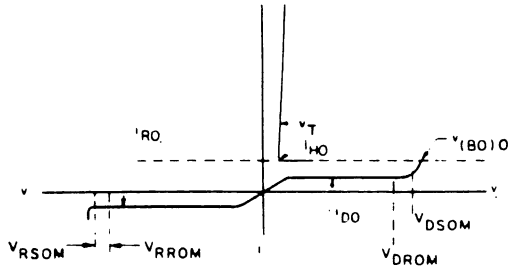


Fig. 1—Principal voltage-current characteristic.

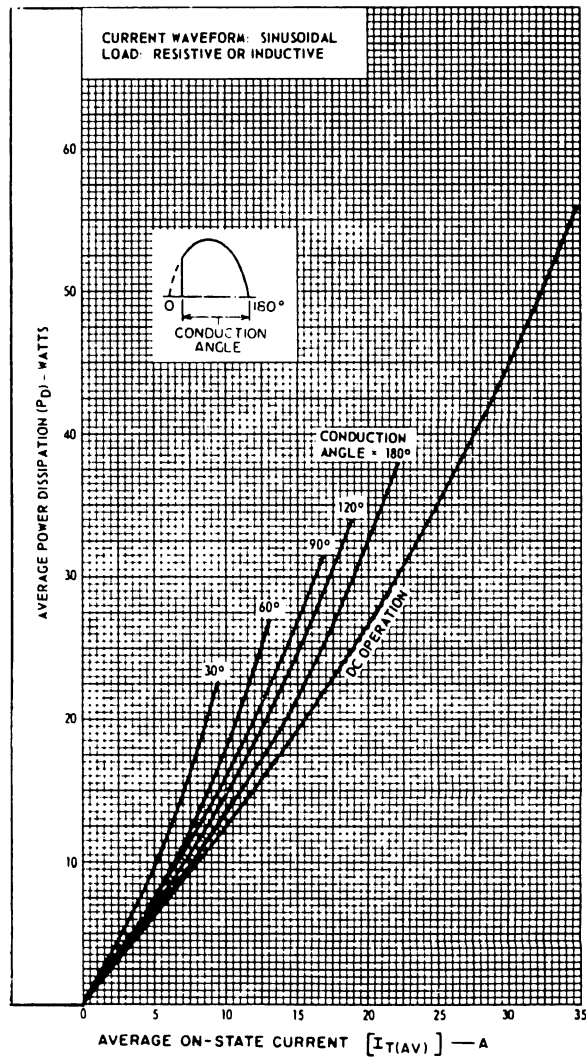


Fig. 2—Power dissipation vs. on-state current.

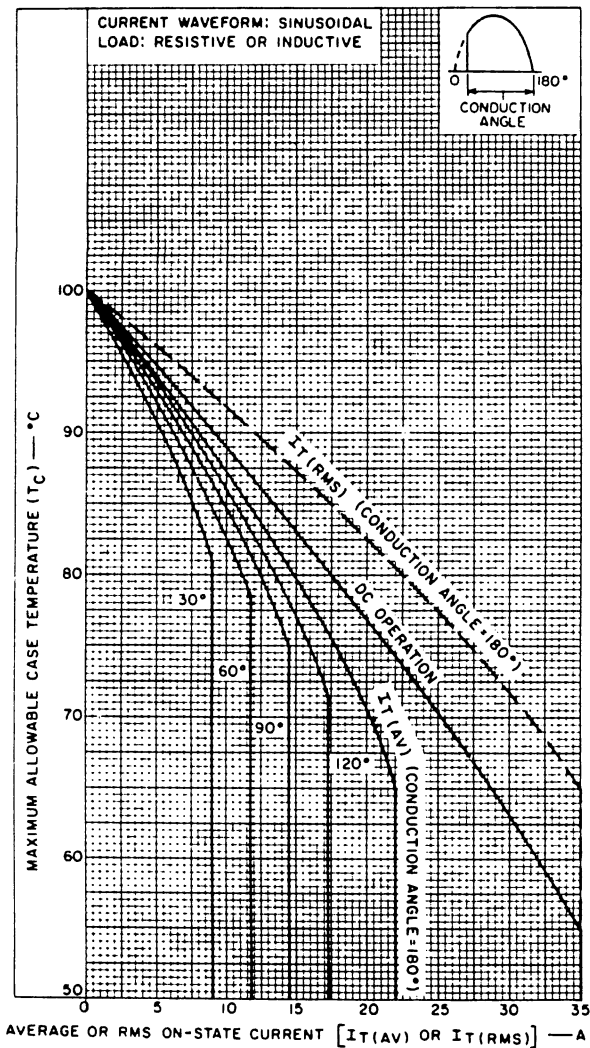


Fig. 3—Maximum allowable case temperature vs. on-state current for press-fit and stud types.

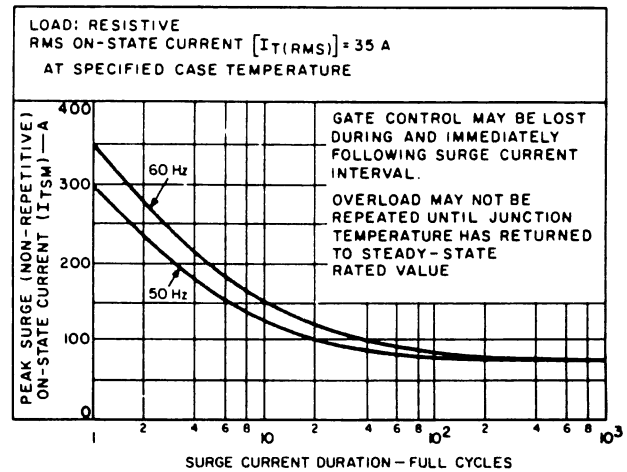


Fig. 4—Peak surge on-state current vs. surge current duration.

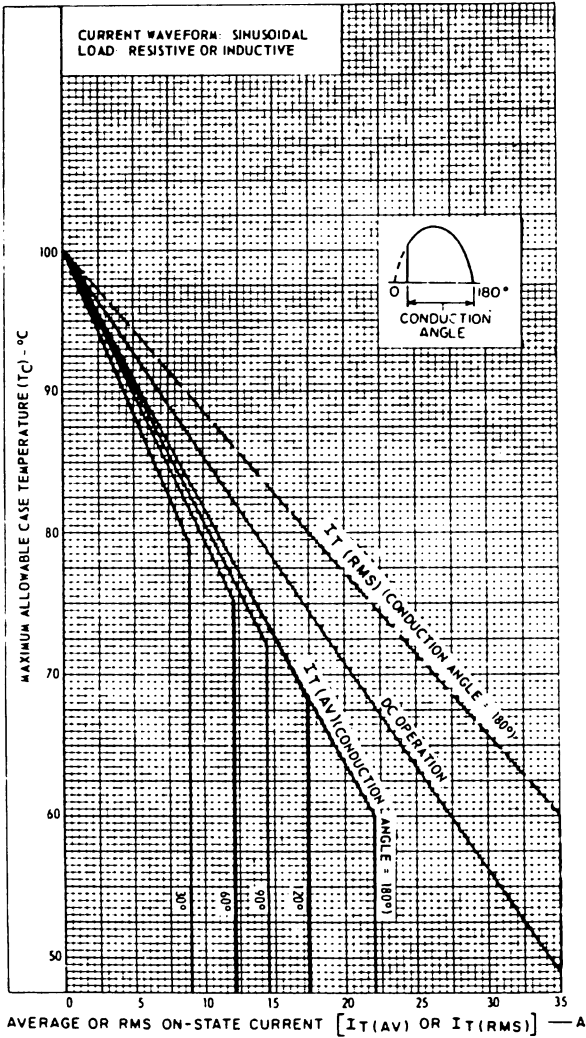


Fig.5—Maximum allowable case temperature vs. on-state current for isolated-stud types.

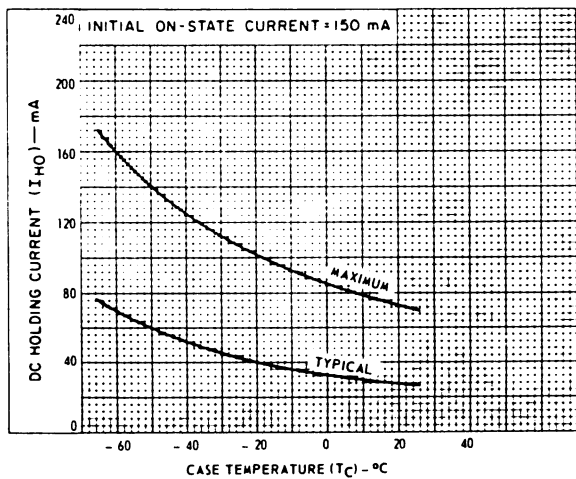


Fig.7—DC holding current vs. case temperature.

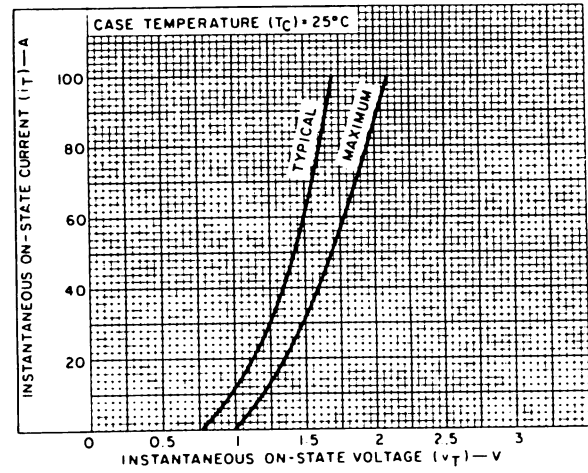


Fig.6—Instantaneous on-state current vs. on-state voltage.

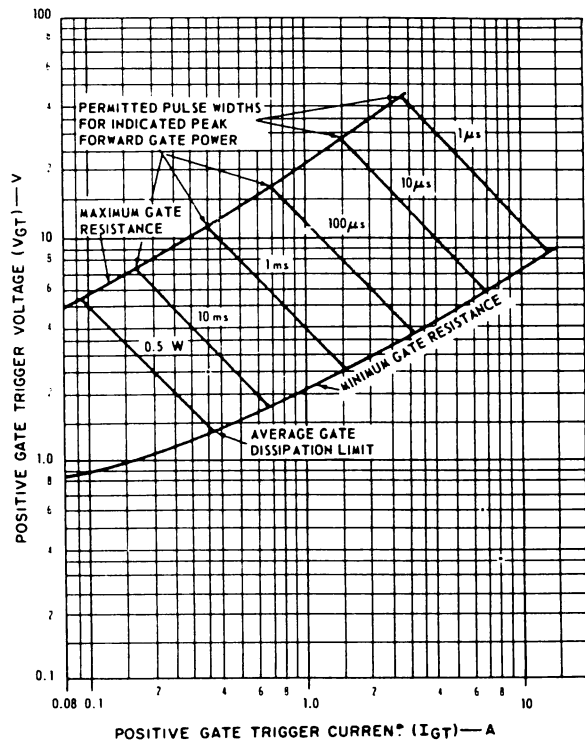


Fig.8—Gate pulse characteristics for forward triggering mode.

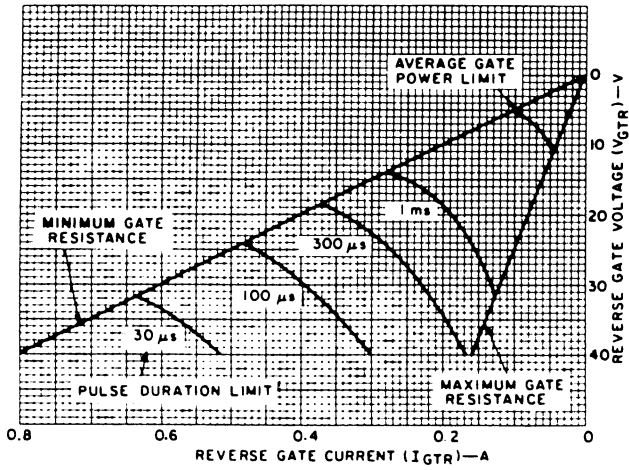


Fig.9—Reverse gate voltage vs. reverse gate current.

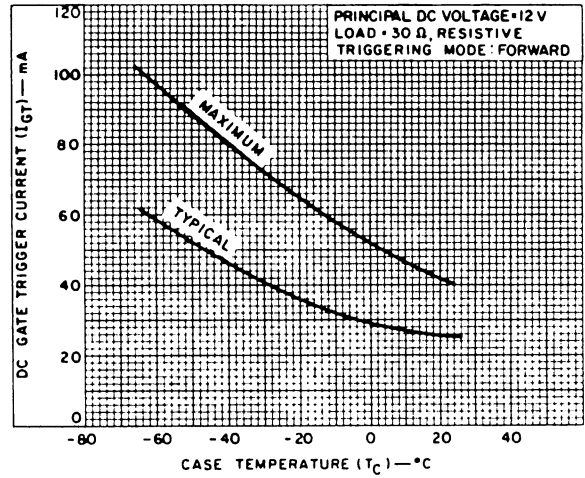


Fig.10—DC gate trigger current (forward) vs. case temperature.

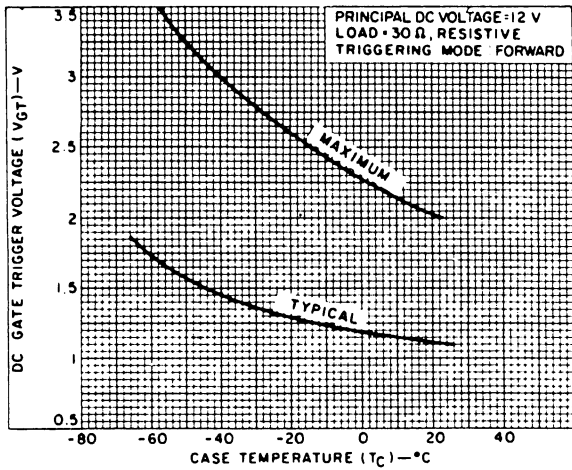


Fig.11—DC gate trigger voltage (forward) vs. case temperature.

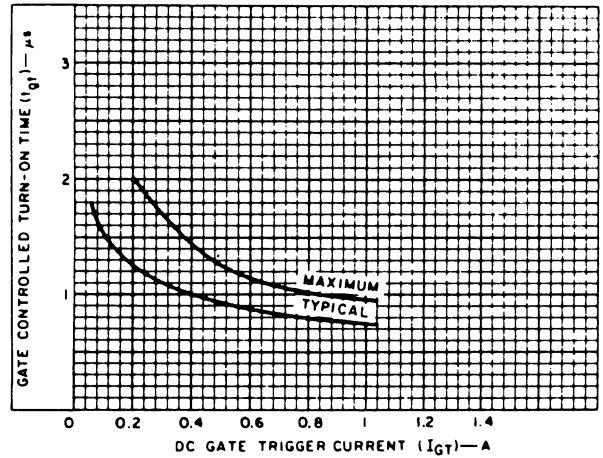


Fig.12—Gate-controlled turn-on time vs. gate trigger current.

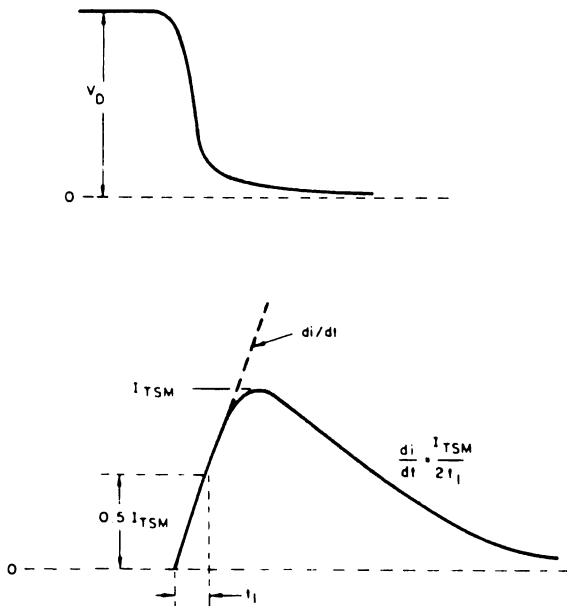


Fig.13—Rate of change of on-state current with time (defining di/dt).

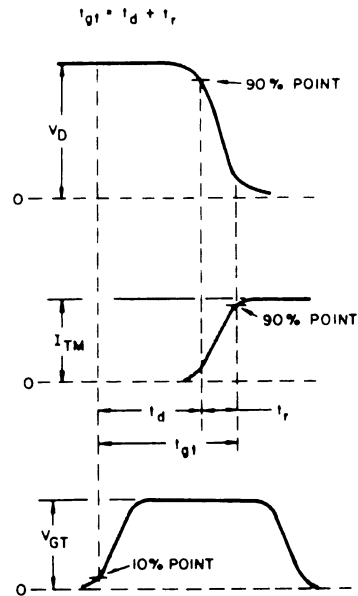


Fig.14—Relationship between off-state voltage, on-state current, and gate trigger voltage showing reference points for definition of turn-on time (t_{gt}).

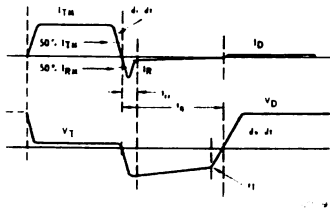


Fig. 15—Relationship between instantaneous on-state current and voltage showing reference points for definition of circuit commutated turn-off time (t_q).

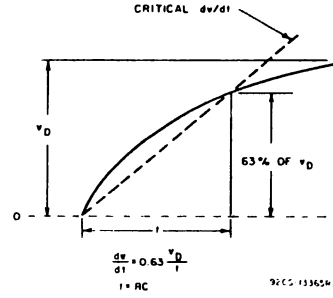
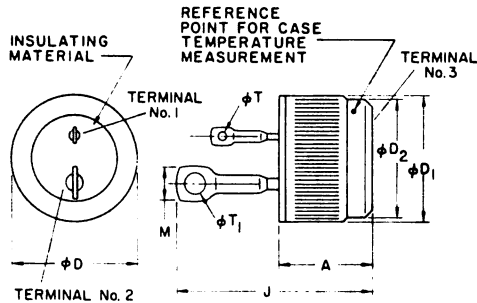


Fig. 16—Rate of rise of off-stage voltage with time (defining critical dv/dt).

**DIMENSIONAL OUTLINE FOR TYPES
2N3870, 2N3871, 2N3872, 2N3873, S6400N
PRESS-FIT**

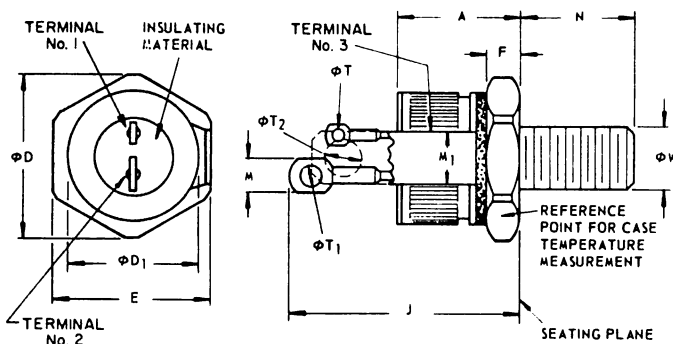


| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|------------|--------|-------|-------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | — | 0.380 | — | 9.65 | |
| ϕD | 0.501 | 0.510 | 12.73 | 12.95 | |
| ϕD_1 | — | 0.505 | — | 12.83 | 2 |
| ϕD_2 | 0.465 | 0.475 | 11.81 | 12.07 | |
| J | — | 0.750 | — | 19.05 | |
| M | — | 0.155 | — | 3.94 | 1 |
| ϕT | 0.058 | 0.068 | 1.47 | 1.73 | |
| ϕT_1 | 0.080 | 0.090 | 2.03 | 2.29 | |

NOTES:

1. Contour and angular orientation of these terminals is optional.
2. Outer diameter of knurled surface.

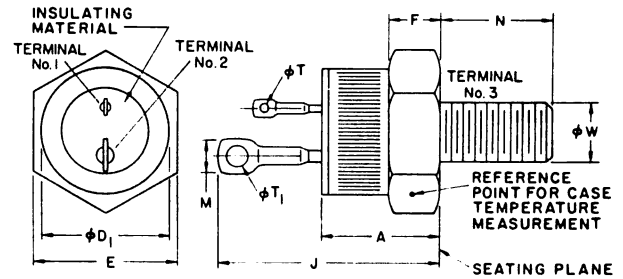
**DIMENSIONAL OUTLINE FOR TYPES
S6420A, B, D, M, N
ISOLATED-STUD**



NOTES:

1. Contour and angular orientation of these terminals is optional.
2. ϕW is pitch diameter of coated threads, Ref: ASA B1, 1-1960. Recommended torque: 50 inch-pounds.
3. A chamfer or undercut on one or both ends of hexagonal portion is optional.

**DIMENSIONAL OUTLINE FOR TYPES
2N3896, 2N3897, 2N3898, 2N3899, S6410N
STUD**



| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|------------|---------------|-------|---------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | 0.330 | 0.505 | 8.4 | 12.8 | |
| ϕD_1 | — | 0.544 | — | 13.81 | |
| E | 0.544 | 0.562 | 13.82 | 14.28 | |
| F | 0.113 | 0.200 | 2.87 | 5.08 | 3 |
| J | — | 0.950 | — | 24.13 | |
| M | — | 0.155 | — | 3.94 | 1 |
| N | 0.422 | 0.453 | 10.72 | 11.50 | |
| ϕT | 0.058 | 0.068 | 1.47 | 1.73 | |
| ϕT_1 | 0.080 | 0.090 | 2.03 | 2.29 | |
| ϕW | 1/4-28 UNF-2A | | 1/4-28 UNF-2A | | 2 |

NOTES:

1. Contour and angular orientation of these terminals is optional.
2. ϕW is pitch diameter of coated threads, Ref: ASA B1, 1-1960. Recommended torque: 50 inch-pounds.
3. A chamfer or undercut on one or both ends of hexagonal portion is optional.

| SYMBOL | INCHES | | MILLIMETERS | | NOTES |
|------------|---------------|-------|---------------|-------|-------|
| | MIN. | MAX. | MIN. | MAX. | |
| A | — | 0.673 | — | 17.09 | |
| ϕD | 0.604 | 0.614 | 15.34 | 15.59 | |
| ϕD_1 | 0.501 | 0.505 | 12.72 | 12.82 | |
| E | 0.551 | 0.557 | 13.99 | 14.14 | |
| F | 0.175 | 0.185 | 4.44 | 4.69 | 3 |
| J | — | 1.055 | — | 26.79 | |
| M | — | 0.155 | — | 3.94 | 1 |
| M_1 | 0.200 | 0.210 | 5.08 | 5.33 | 1 |
| N | 0.422 | 0.452 | 10.72 | 11.48 | |
| ϕT | 0.058 | 0.068 | 1.47 | 1.73 | |
| ϕT_1 | 0.080 | 0.090 | 2.03 | 2.29 | |
| ϕT_2 | 0.138 | 0.148 | 3.50 | 3.75 | |
| ϕW | 1/4-28 UNF-2A | | 1/4-28 UNF-2A | | 2 |

TERMINAL CONNECTIONS FOR ALL TYPES

- No. 1 — Gate
- No. 2 — Cathode
- Case, No. 3 — Anode